



US00D657756S

(12) **United States Design Patent**  
**Mueller**

(10) **Patent No.:** **US D657,756 S**

(45) **Date of Patent:** **\*\* Apr. 17, 2012**

(54) **LOW PROFILE HEAT SPREADER FOR A  
COMPUTER MEMORY MODULE**

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(US)

(\*\*) Term: **14 Years**

(21) Appl. No.: **29/404,205**

(22) Filed: **Oct. 17, 2011**

(51) **LOC (9) Cl.** ..... **13-03**

(52) **U.S. Cl.** ..... **D13/179**

(58) **Field of Classification Search** ..... D13/179;

165/80.3, 104.26, 104.33, 122, 151, 185;

257/706, 707, 718-722; 361/695, 697, 700,

361/702, 704, 709, 710, 711, 719

See application file for complete search history.

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(57) **CLAIM**

The ornamental design for a low profile heat spreader for a computer memory module, as shown and described.

**DESCRIPTION**

FIG. 1 is a front right side perspective view of a low profile heat spreader for a computer memory module showing our design;

FIG. 2 is a front view of the low profile heat spreader for a computer memory module;

FIG. 3 is a rear view of the low profile heat spreader for a computer memory module;

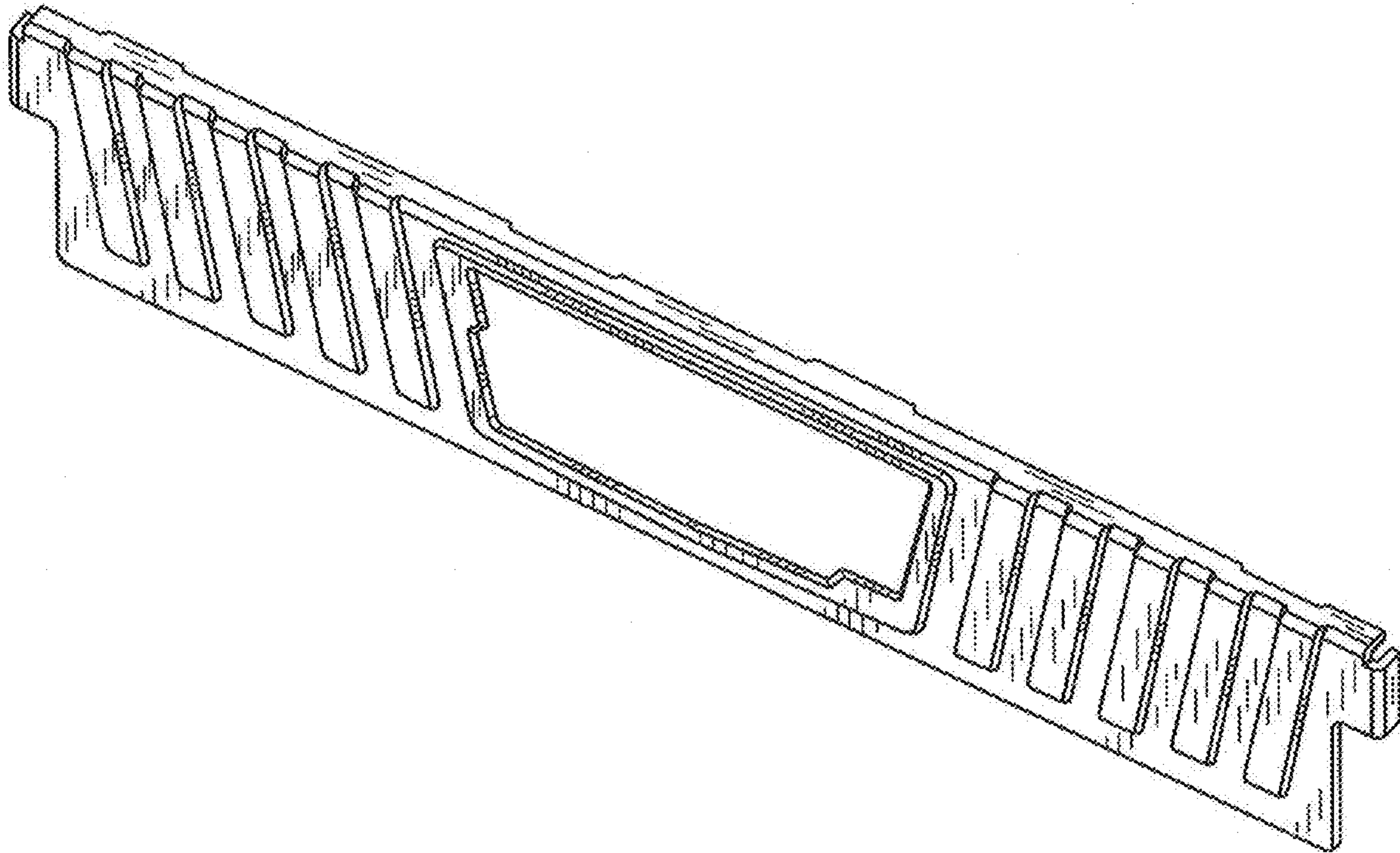
FIG. 4 is a top side view of the low profile heat spreader for a computer memory module;

FIG. 5 is a bottom side view of the low profile heat spreader for a computer memory module; and,

FIG. 6 is a right or left side view of the low profile heat spreader for a computer memory module.

The shade lines in the figures show contour and not surface ornamentation.

**1 Claim, 4 Drawing Sheets**



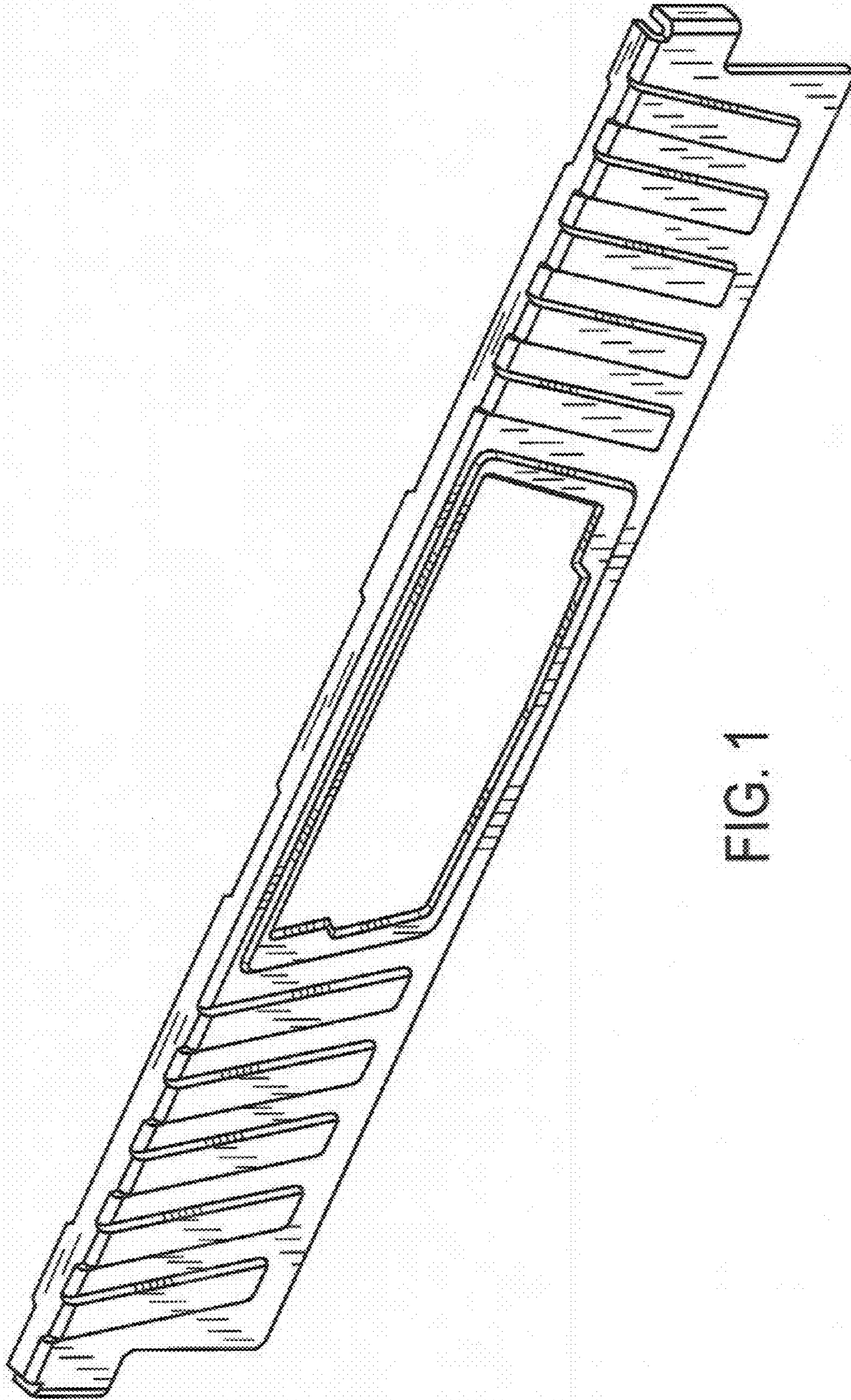


FIG. 1

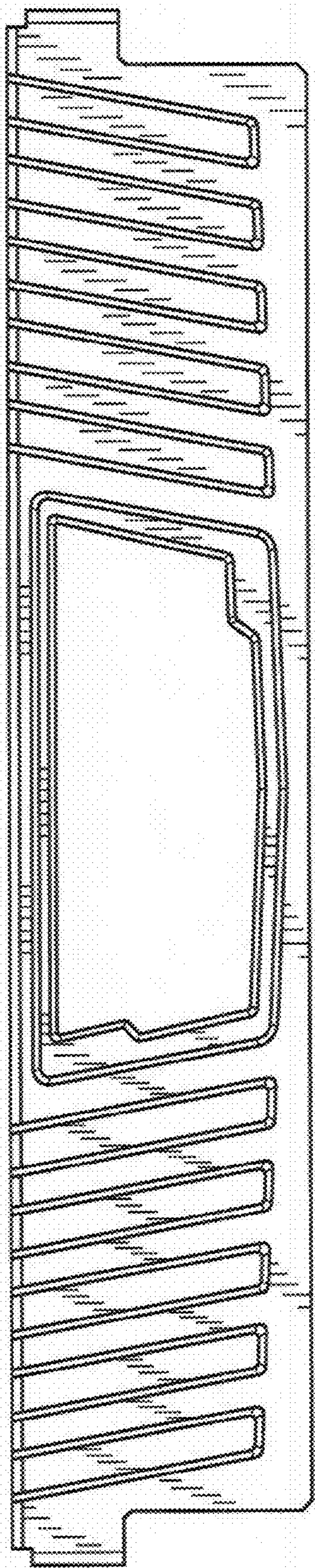


FIG. 2

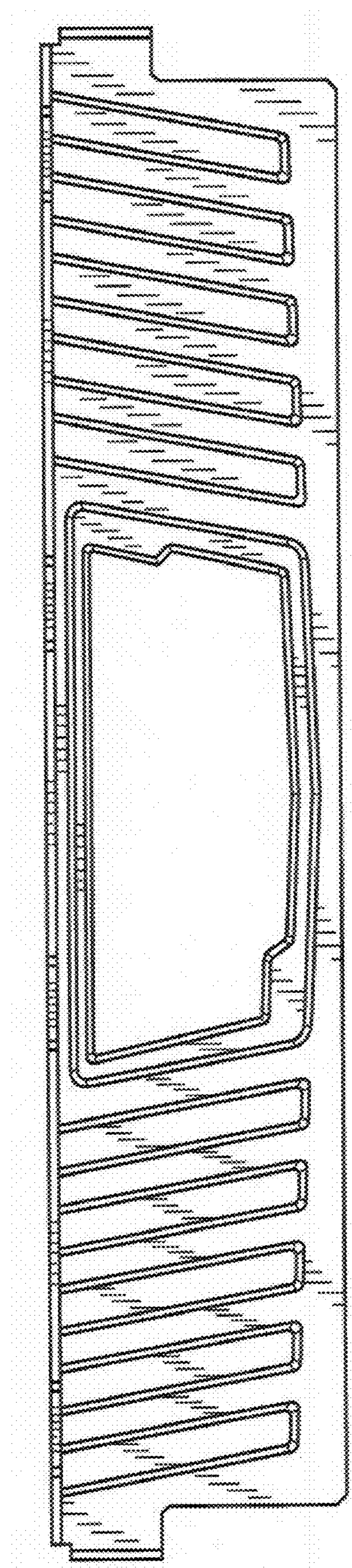


FIG. 3



FIG. 4

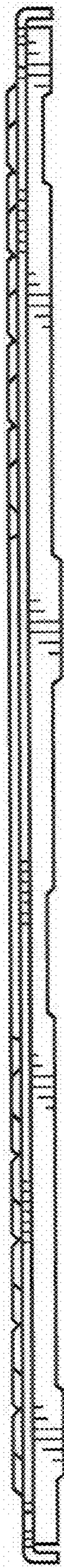


FIG. 5



FIG. 6